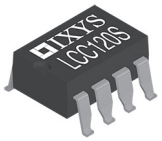
LCC120
1-Form-C OptoMOS® Relay

IXYS INTEGRATED CIRCUITS DIVISION



Parameters	Ratings	Units
Blocking Voltage	250	V_P
Load Current	170	mA_{rms} / mA_{DC}
On-Resistance (max)	20	Ω

Features
- 3750V_{rms} Input/Output Isolation
- 1-Form-C Solid State Relay
- Low Drive Power Requirements
- High Reliability
- Arc-Free With No Snubbing Circuits
- FCC Compatible
- VDE Compatible
- No EMI/RFI Generation
- Small 8-pin Package
- Flammability Rating UL 94 V-0
- Surface Mount Tape & Reel Versions Available

Applications
- Telecommunications
  - Telecom Switching
  - Tip/Ring Circuits
  - Modem Switching (Laptop, Notebook, Pocket Size)
  - Hook Switch
  - Dial Pulsing
  - Ground Start
  - Ringing Injection
- Instrumentation
- Multiplexers
- Data Acquisition
- Electronic Switching
- I/O Subsystems
- Meters (Watt-Hour, Water, Gas)
- Medical Equipment—Patient/Equipment Isolation
- Security
- Aerospace
- Industrial Controls

Description
LCC120P is a 250V, 170mA, 20Ω, 1-Form-C relay. It is ideal for applications focused on peak load current handling capablilities.

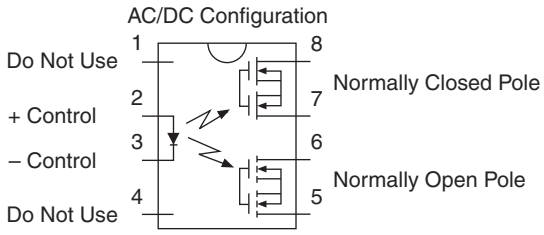
This device is perfect for applications where a signal needs to be switched between two different lines. The small 8-lead package makes it an ideal space-saving replacement for a 1-Form-C electromechanical relay (EMR).

Approvals
- UL Recognized Component: File E76270
- CSA Certified Component: Certificate # 1175739
- EN/IEC 60950-1 Certified Component: Certificate available on our website

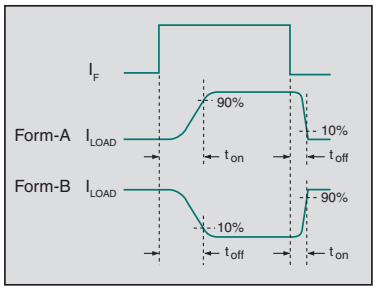
Ordering Information

Part #	Description
LCC120	8-Pin DIP (50/Tube)
LCC120S	8-Pin Surface Mount (50/Tube)
LCC120STR	8-Pin Surfact Mount Tape & Reel (1000/Reel)

Pin Configuration



Switching Characteristics for a Form-C Device



www.datasheet.world

Absolute Maximum Ratings @ 25ºC

Parameter	Min	Max	Unit
Blocking Voltage	-	250	V_P
Reverse Input Voltage	-	5	V
Input control Current	-	50	mA
Peak (10ms)	-	1	A
Input Power Dissipation [1]	-	150	mW
Total Power Dissipation [2]	-	800	mW
Isolation Voltage, Input to Output	3750	-	V_{rms}
Operating Temperature	-40	+85	ºC
Storage Temperature	-40	+125	ºC

[1] Derate linearly 1.33mW / ºC.
[2] Derate linearly 6.67mW / ºC.

Absolute Maximum Ratings are stress ratings. Stresses in excess of these ratings can cause permanent damage to the device. Functional operation of the device at conditions beyond those indicated in the operational sections of this data sheet is not implied.

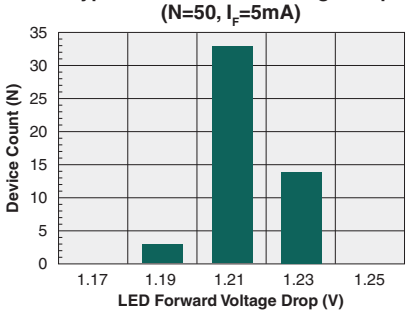
Typical values are characteristic of the device at +25°C, and are the result of engineering evaluations. They are provided for information purposes only, and are not part of the manufacturing testing requirements.

Electrical Characteristics @ 25ºC

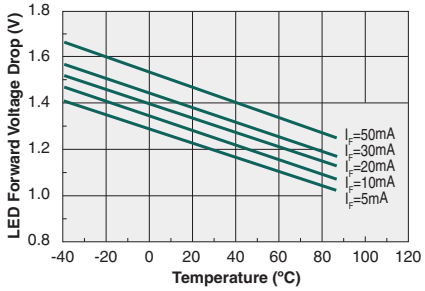
Parameter	Conditions	Symbol	Min	Typ	Max	Units
Output Characteristics						
Load Current						
Continuous, AC/DC Configuration	-	I_L	-	-	170	mA_{rms} / mA_{DC}
Peak	t=10ms	I_{LPK}	-	-	±400	mA_P
On-Resistance, AC/DC Configuration	I_L=170mA	R_{ON}	-	16	20	Ω
Off-State Leakage Current	V_L=250V_P	I_{LEAK}	-	-	1	µA
Switching Speeds						
Turn-On	I_F=10mA, V_L=10V	t_{on}	-	-	5	ms
Turn-Off		t_{off}	-	-	5	
Output Capacitance	V_L=50V, f=1MHz	C_{OUT}	-	50	-	pF
Input Characteristics						
Input Control Current to Activate	I_L=170mA	I_F	-	-	10	mA
Input Control Current to Deactivate	-	I_F	0.4	0.7	-	mA
Input Voltage Drop	I_F=10mA	V_F	0.9	1.35	1.56	V
Reverse Input Current	V_R=5V	I_R	-	-	10	µA
Common Characteristics						
Capacitance, Input to Output	V_{IO}=0V, f=1MHz	C_{IO}	-	3	-	pF

COMMON PERFORMANCE DATA*

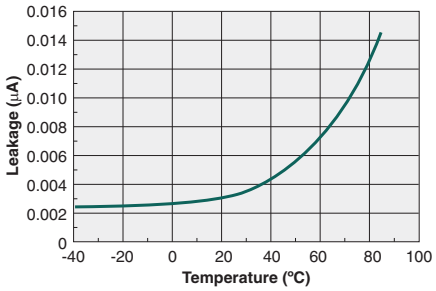
Typical LED Forward Voltage Drop
(N=50, I_F=5mA)



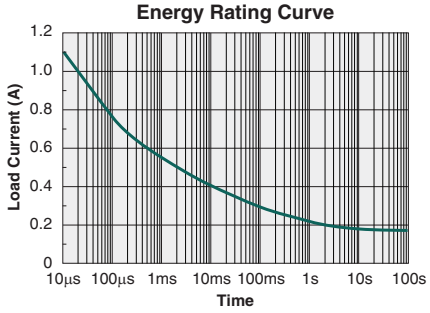
Typical LED Forward Voltage Drop
vs. Temperature



Typical Leakage vs. Temperature
Measured across Pins 5&6 or 7&8

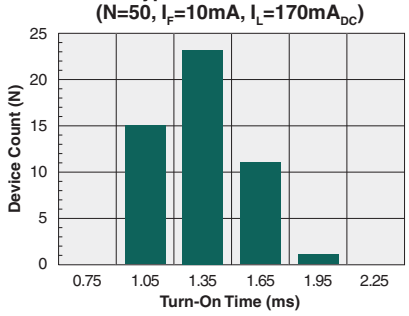


Energy Rating Curve

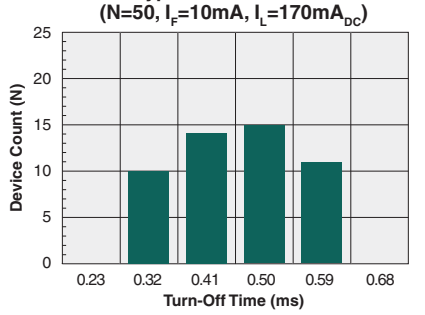


FORM-A RELAY PERFORMANCE DATA*

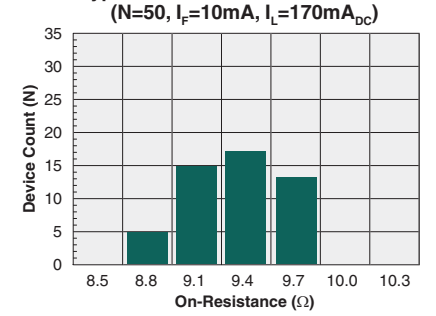
Form-A
Typical Turn-On Time
(N=50, I_F=10mA, I_L=170mA$_{DC}$)



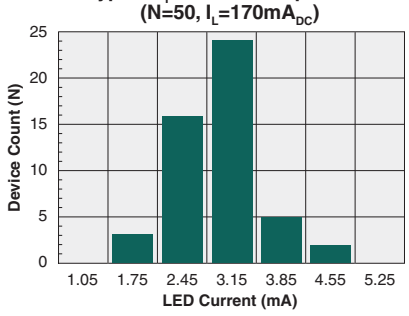
Form-A
Typical Turn-Off Time
(N=50, I_F=10mA, I_L=170mA$_{DC}$)



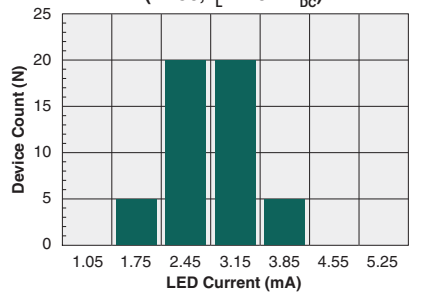
Form-A
Typical On-Resistance Distribution
(N=50, I_F=10mA, I_L=170mA$_{DC}$)



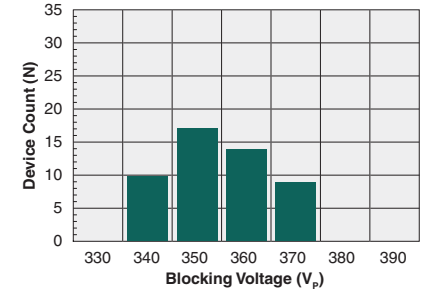
Form-A
Typical I_F for Switch Operation
(N=50, I_L=170mA$_{DC}$)



Form-A
Typical I_F for Switch Dropout
(N=50, I_L=170mA$_{DC}$)



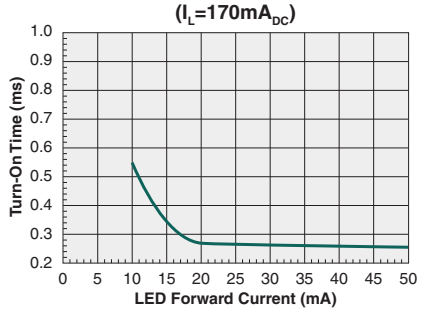
Form-A
Typical Blocking Voltage Distribution
(N=50)



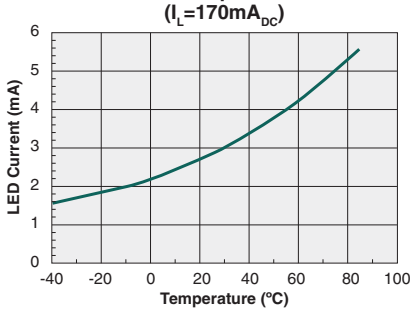
*Unless otherwise noted, data presented in these graphs is typical of device operation at 25°C.
For guaranteed parameters not indicated in the written specifications, please contact our application department.

FORM-A RELAY PERFORMANCE DATA*

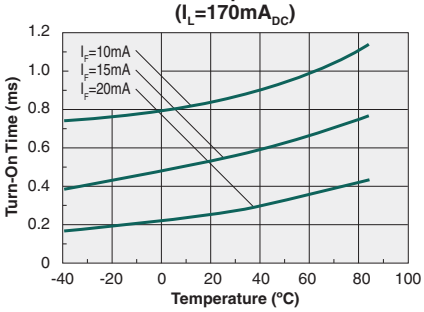
Form-A
Typical Turn-On Time
vs. LED Forward Current
(I_L=170mA$_{DC}$)



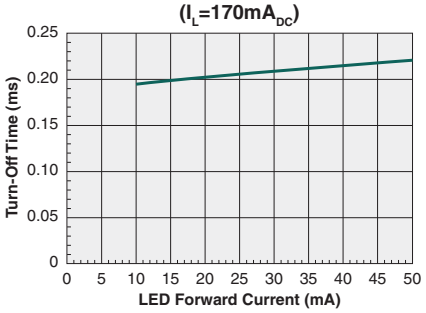
Form-A
Typical I_F for Switch Operation
vs. Temperature
(I_L=170mA$_{DC}$)



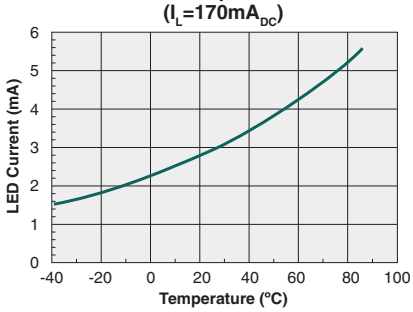
Form-A
Typical Turn-On Time
vs. Temperature
(I_L=170mA$_{DC}$)



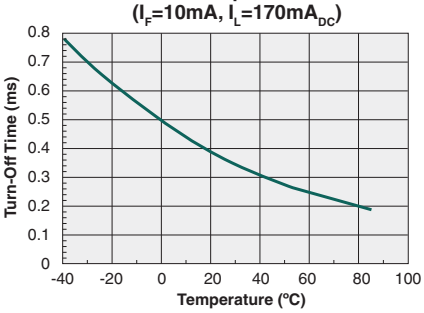
Form-A
Typical Turn-Off Time
vs. LED Forward Current
(I_L=170mA$_{DC}$)



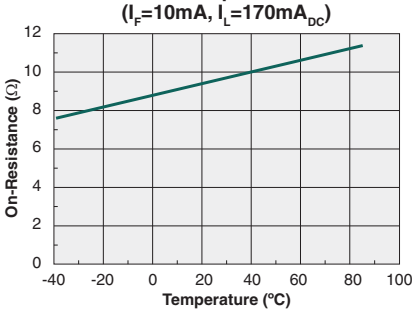
Form-A
Typical I_F for Switch Dropout
vs. Temperature
(I_L=170mA$_{DC}$)



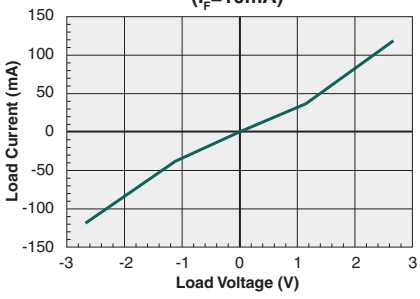
Form-A
Typical Turn-Off Time
vs. Temperature
(I_F=10mA, I_L=170mA$_{DC}$)



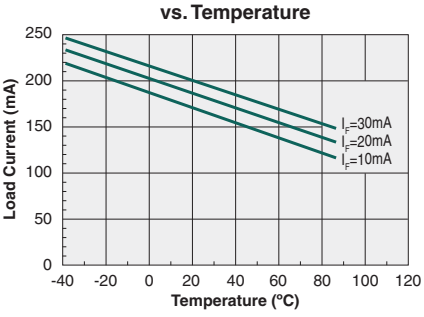
Form-A
Typical On-Resistance
vs. Temperature
(I_F=10mA, I_L=170mA$_{DC}$)



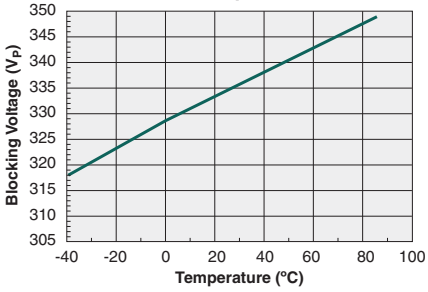
Form-A
Typical Load Current vs. Load Voltage
(I_F=10mA)



Form-A
Maximum Load Current
vs. Temperature



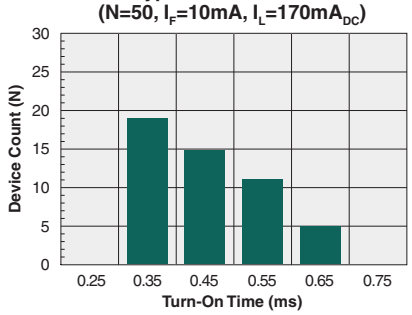
Form-A
Typical Blocking Voltage
vs. Temperature



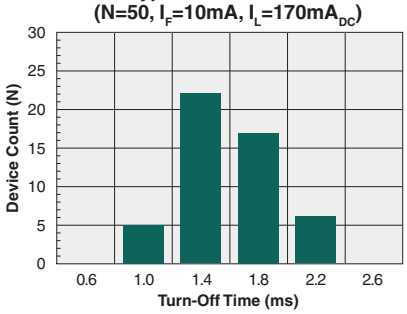
*Unless otherwise noted, data presented in these graphs is typical of device operation at 25ºC.
For guaranteed parameters not indicated in the written specifications, please contact our application department.

FORM-B RELAY PERFORMANCE DATA*

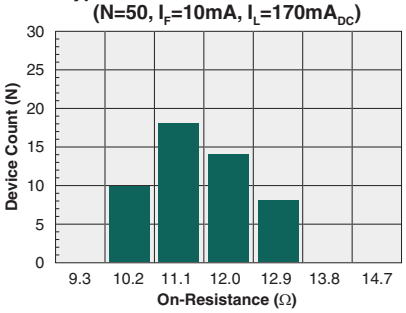
Form-B
Typical Turn-On Time
(N=50, I_F=10mA, I_L=170mA$_{DC}$)



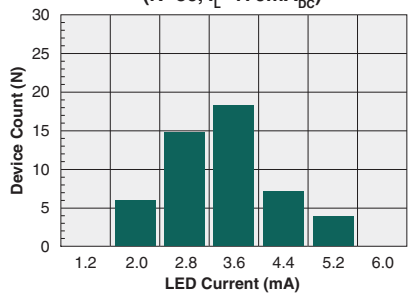
Form-B
Typical Turn-Off Time
(N=50, I_F=10mA, I_L=170mA$_{DC}$)



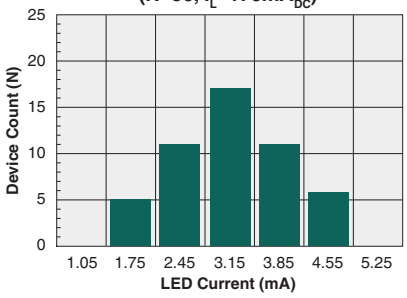
Form-B
Typical On-Resistance Distribution
(N=50, I_F=10mA, I_L=170mA$_{DC}$)



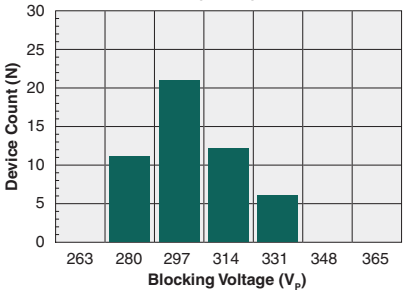
Form-B
Typical I_F for Switch Operation
(N=50, I_L=170mA$_{DC}$)



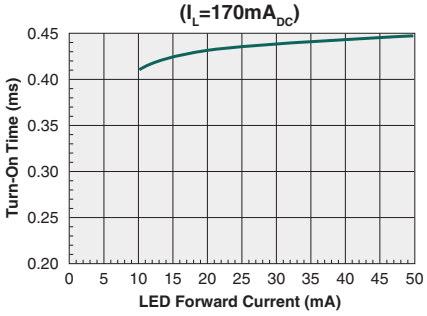
Form-B
Typical I_F for Switch Dropout
(N=50, I_L=170mA$_{DC}$)



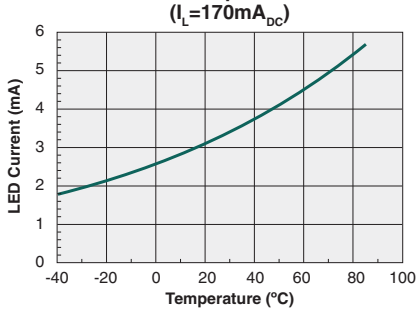
Form-B
Typical Blocking Voltage Distribution
(N=50)



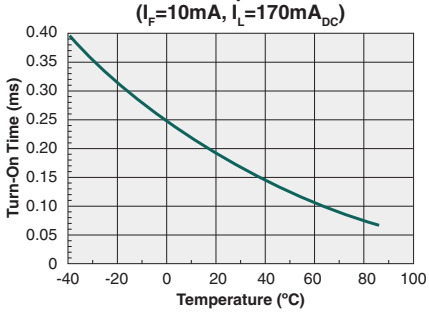
Form-B
Typical Turn-On Time
vs.LED Forward Current
(I_L=170mA$_{DC}$)



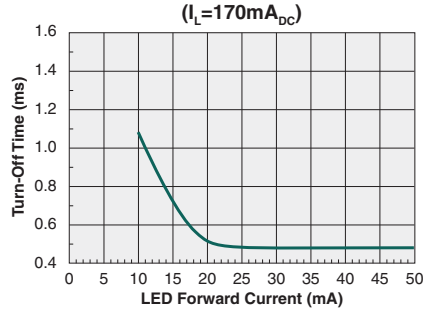
Form-B
Typical I_F for Switch Operation
vs. Temperature
(I_L=170mA$_{DC}$)



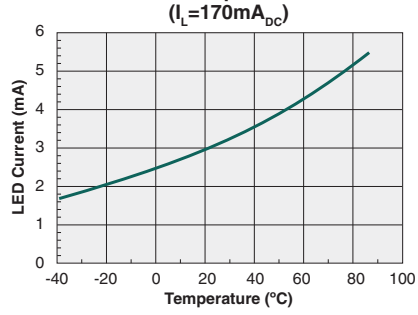
Form-B
Typical Turn-On Time
vs. Temperature
(I_F=10mA, I_L=170mA$_{DC}$)



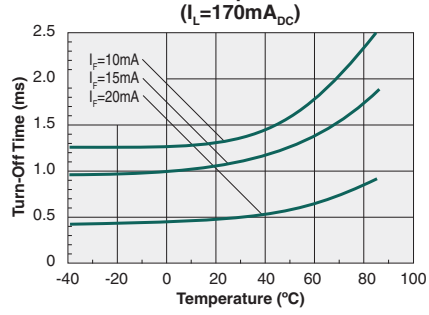
Form-B
Typical Turn-Off Time
vs. LED Forward Current
(I_L=170mA$_{DC}$)



Form-B
Typical I_F for Switch Dropout
vs. Temperature
(I_L=170mA$_{DC}$)



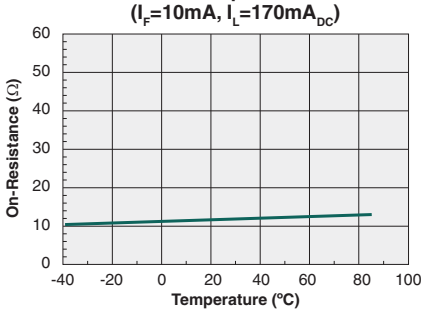
Form-B
Typical Turn-Off Time
vs. Temperature
(I_L=170mA$_{DC}$)



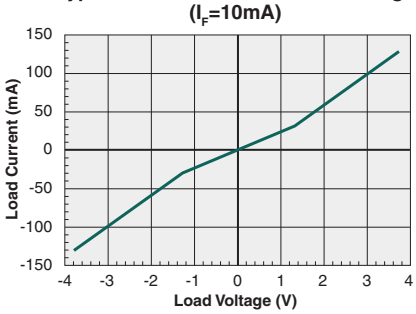
*Unless otherwise noted, data presented in these graphs is typical of device operation at 25°C.
For guaranteed parameters not indicated in the written specifications, please contact our application department.

FORM-B RELAY PERFORMANCE DATA*

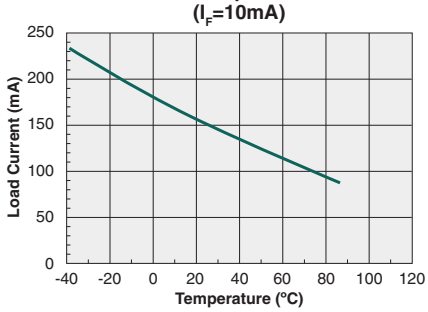
Form-B
Typical On-Resistance
vs. Temperature
(I_F=10mA, I_L=170mA$_{DC}$)



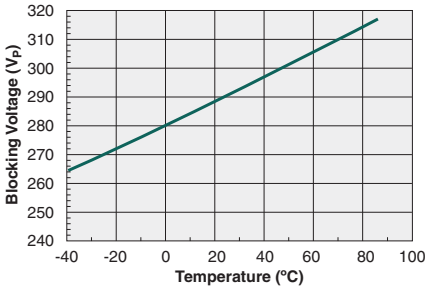
Form-B
Typical Load Current vs. Load Voltage
(I_F=10mA)



Form B
Maximum Load Current
vs. Temperature
(I_F=10mA)



Form-B
Typical Blocking Voltage
vs. Temperature



*Unless otherwise noted, data presented in these graphs is typical of device operation at 25°C.
For guaranteed parameters not indicated in the written specifications, please contact our application department.

Manufacturing Information

Moisture Sensitivity

All plastic encapsulated semiconductor packages are susceptible to moisture ingression. IXYS Integrated Circuits classifies its plastic encapsulated devices for moisture sensitivity according to the latest version of the joint industry standard, **IPC/JEDEC J-STD-020**, in force at the time of product evaluation. We test all of our products to the maximum conditions set forth in the standard, and guarantee proper operation of our devices when handled according to the limitations and information in that standard as well as to any limitations set forth in the information or standards referenced below.

Failure to adhere to the warnings or limitations as established by the listed specifications could result in reduced product performance, reduction of operable life, and/or reduction of overall reliability.

This product carries a Moisture Sensitivity Level (MSL) classification as shown below, and should be handled according to the requirements of the latest version of the joint industry standard **IPC/JEDEC J-STD-033**.

Device	Moisture Sensitivity Level (MSL) Classification
LCC120 / LCC120S	MSL 1

ESD Sensitivity

This product is **ESD Sensitive**, and should be handled according to the industry standard **JESD-625**.

Soldering Profile

Provided in the table below is the Classification Temperature (T_C) of this product and the maximum dwell time the body temperature of this device may be (T_C - 5)°C or greater. The classification temperature sets the Maximum Body Temperature allowed for this device during lead-free reflow processes. For through-hole devices, and any other processes, the guidelines of **J-STD-020** must be observed.

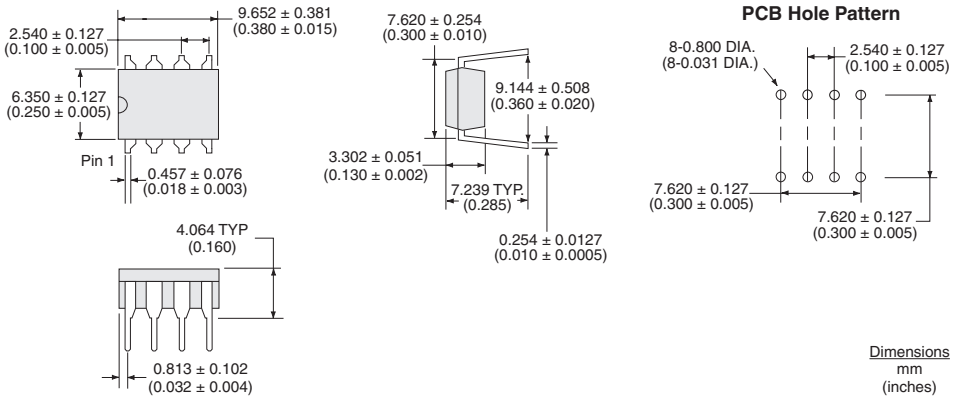
Device	Classification Temperature (T_c)	Dwell Time (t_p)	Max Reflow Cycles
LCC120	250°C	30 seconds	1
LCC120S	250°C	30 seconds	3

Board Wash

IXYS Integrated Circuits recommends the use of no-clean flux formulations. Board washing to reduce or remove flux residue following the solder reflow process is acceptable provided proper precautions are taken to prevent damage to the device. These precautions include, but are not limited to: using a low pressure wash and providing a follow up bake cycle sufficient to remove any moisture trapped within the device due to the washing process. Due to the variability of the wash parameters used to clean the board, determination of the bake temperature and duration necessary to remove the moisture trapped within the package is the responsibility of the user (assembler). Cleaning or drying methods that employ ultrasonic energy may damage the device and should not be used. Additionally, the device must not be exposed to flux or solvents that are Chlorine- or Fluorine-based.

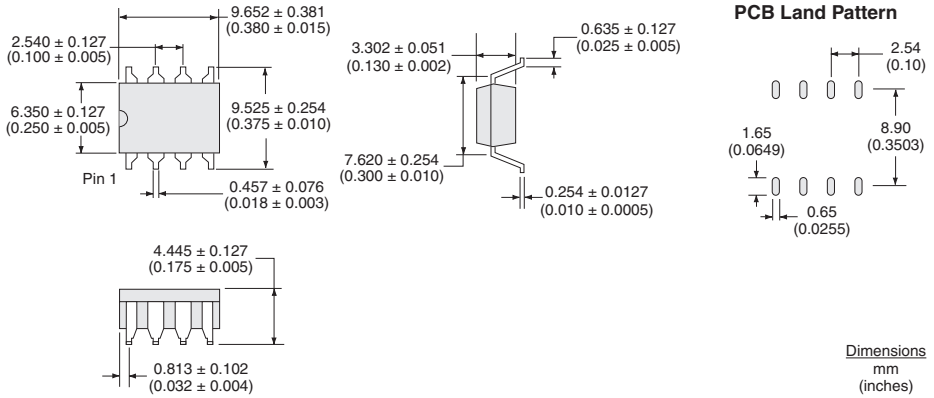
Mechanical Dimensions

LCC120



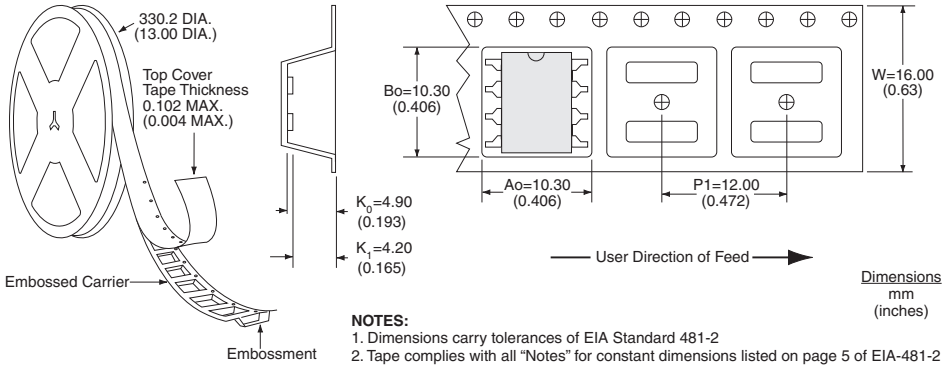
Dimensions
mm
(inches)

LCC120S



Dimensions
mm
(inches)

LCC120STR Tape & Reel



Dimensions
mm
(inches)

NOTES:
1. Dimensions carry tolerances of EIA Standard 481-2
2. Tape complies with all "Notes" for constant dimensions listed on page 5 of EIA-481-2

For additional information please visit our website at: www.ixysic.com

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Specification: DS-LCC120-R10
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